

DATA SHEET

74LV10

Triple 3-input NAND gate

Product data
Supersedes data of 1998 Apr 20

2003 Mar 04

Triple 3-input NAND gate

74LV10

FEATURES

- Optimized for Low Voltage applications: 1.0 V to 3.6 V
- Accepts TTL input levels between $V_{CC} = 2.7$ V and $V_{CC} = 3.6$ V
- Typical V_{OLP} (output ground bounce) < 0.8 V at $V_{CC} = 3.3$ V, $T_{amb} = 25$ °C.
- Typical V_{OHV} (output V_{OH} undershoot) > 2 V at $V_{CC} = 3.3$ V, $T_{amb} = 25$ °C.
- Output capability: standard
- I_{CC} category: SSI

DESCRIPTION

The 74LV10 is a low-voltage Si-gate CMOS device and is pin and function compatible with 74HC/HCT10.

The 74LV10 provides the 3-input NAND function.

QUICK REFERENCE DATA

GND = 0 V; $T_{amb} = 25$ °C; $t_r = t_f \leq 2.5$ ns

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t_{PHL}/t_{PLH}	Propagation delay nA, nB, nC to nY	$C_L = 15$ pF; $V_{CC} = 3.3$ V	9	ns
C_I	Input capacitance		3.5	pF
C_{PD}	Power dissipation capacitance per gate	See Notes 1 and 2	12	pF

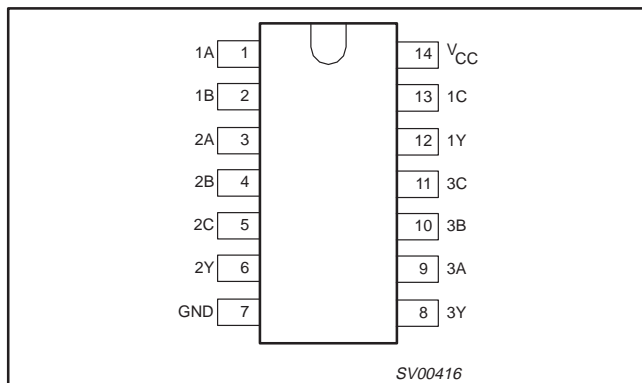
NOTES:

- C_{PD} is used to determine the dynamic power dissipation (P_D in μ W)
 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:
 N = number of outputs switching;
 f_i = input frequency in MHz; C_L = output load capacitance in pF;
 f_o = output frequency in MHz; V_{CC} = supply voltage in V;
 $\Sigma (C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.
- The condition is $V_I = \text{GND to } V_{CC}$

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	ORDER CODE	PKG. DWG. #
14-Pin Plastic SO	-40 °C to +125 °C	74LV10D	SOT108-1

PIN CONFIGURATION



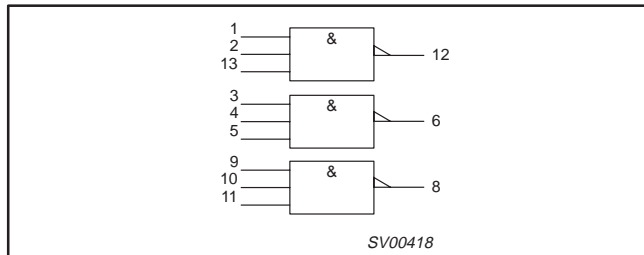
PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 3, 9	1A – 3A	Data inputs
2, 4, 10	1B – 3B	Data inputs
7	GND	Ground (0 V)
12, 6, 8	1Y – 3Y	Data outputs
13, 5, 11	1C – 3C	Data inputs
14	V_{CC}	Positive supply voltage

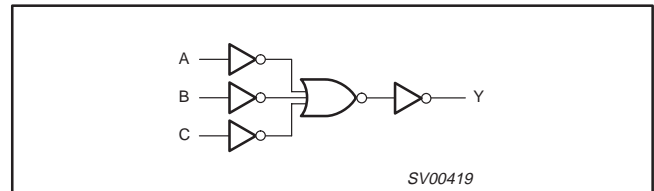
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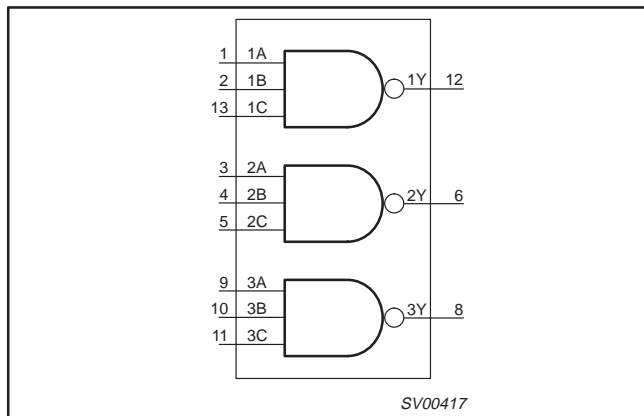
LOGIC SYMBOL (IEEE/IEC)



LOGIC DIAGRAM (ONE GATE)



LOGIC SYMBOL



FUNCTION TABLE

INPUTS			OUTPUTS
nA	nB	nC	nY
L	L	L	H
L	L	H	H
L	H	L	H
L	H	H	H
H	L	L	H
H	L	H	H
H	H	L	H
H	H	H	L

NOTES:
 H = HIGH voltage level
 L = LOW voltage level

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP.	MAX	UNIT
V_{CC}	DC supply voltage	See Note1	1.0	3.3	3.6	V
V_I	Input voltage		0	–	V_{CC}	V
V_O	Output voltage		0	–	V_{CC}	V
T_{amb}	Operating ambient temperature range in free air	See DC and AC characteristics	–40 –40		+85 +125	°C
t_r, t_f	Input rise and fall times	$V_{CC} = 1.0\text{ V to }2.0\text{ V}$	–	–	500	ns/V
		$V_{CC} = 2.0\text{ V to }2.7\text{ V}$	–	–	200	ns/V
		$V_{CC} = 2.7\text{ V to }3.6\text{ V}$	–	–	100	ns/V

NOTE:
 1. The LV is guaranteed to function down to $V_{CC} = 1.0\text{ V}$ (input levels GND or V_{CC}); DC characteristics are guaranteed from $V_{CC} = 1.2\text{ V}$ to $V_{CC} = 3.6\text{ V}$.

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ABSOLUTE MAXIMUM RATINGS^{1, 2}

In accordance with the Absolute Maximum Rating System (IEC 134).

Voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V_{CC}	DC supply voltage		-0.5 to +4.6	V
$\pm I_{IK}$	DC input diode current	$V_I < -0.5 \text{ V}$ or $V_I > V_{CC} + 0.5 \text{ V}$	20	mA
$\pm I_{OK}$	DC output diode current	$V_O < -0.5 \text{ V}$ or $V_O > V_{CC} + 0.5 \text{ V}$	50	mA
$\pm I_O$	DC output source or sink current (standard outputs)	$-0.5 \text{ V} < V_O < V_{CC} + 0.5 \text{ V}$	25	mA
$\pm I_{GND}$, $\pm I_{CC}$	DC V_{CC} or GND current for types with standard outputs		50	mA
T_{stg}	Storage temperature range		-65 to +150	°C
P_{TOT}	Power dissipation per package – plastic mini-pack (SO)	for temperature range: -40 °C to +125 °C above +70 °C derate linearly with 8 mW/K	500	mW

NOTES:

- Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS					UNIT
			-40 °C to +85 °C			-40 °C to +125 °C		
			MIN	TYP ¹	MAX	MIN	MAX	
V_{IH}	HIGH level Input voltage	$V_{CC} = 1.2 \text{ V}$	0.9			0.9		V
		$V_{CC} = 2.0 \text{ V}$	1.4			1.4		
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0			2.0		
V_{IL}	LOW level Input voltage	$V_{CC} = 1.2 \text{ V}$			0.3		0.3	V
		$V_{CC} = 2.0 \text{ V}$			0.6		0.6	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$			0.8		0.8	
V_{OH}	HIGH level output voltage; all outputs	$V_{CC} = 1.2 \text{ V}; V_I = V_{IH}$ or $V_{IL}; -I_O = 100 \mu\text{A}$		1.2				V
		$V_{CC} = 2.0 \text{ V}; V_I = V_{IH}$ or $V_{IL}; -I_O = 100 \mu\text{A}$	1.8	2.0		1.8		
		$V_{CC} = 2.7 \text{ V}; V_I = V_{IH}$ or $V_{IL}; -I_O = 100 \mu\text{A}$	2.5	2.7		2.5		
		$V_{CC} = 3.0 \text{ V}; V_I = V_{IH}$ or $V_{IL}; -I_O = 100 \mu\text{A}$	2.8	3.0		2.8		
V_{OH}	HIGH level output voltage; STANDARD outputs	$V_{CC} = 3.0 \text{ V}; V_I = V_{IH}$ or $V_{IL}; -I_O = 6 \text{ mA}$	2.40	2.82		2.20		V
V_{OL}	LOW level output voltage; all outputs	$V_{CC} = 1.2 \text{ V}; V_I = V_{IH}$ or $V_{IL}; I_O = 100 \mu\text{A}$		0				V
		$V_{CC} = 2.0 \text{ V}; V_I = V_{IH}$ or $V_{IL}; I_O = 100 \mu\text{A}$		0	0.2		0.2	
		$V_{CC} = 2.7 \text{ V}; V_I = V_{IH}$ or $V_{IL}; I_O = 100 \mu\text{A}$		0	0.2		0.2	
		$V_{CC} = 3.0 \text{ V}; V_I = V_{IH}$ or $V_{IL}; I_O = 100 \mu\text{A}$		0	0.2		0.2	
V_{OL}	LOW level output voltage; STANDARD outputs	$V_{CC} = 3.0 \text{ V}; V_I = V_{IH}$ or $V_{IL}; I_O = 6 \text{ mA}$		0.25	0.40		0.50	V
I_I	Input leakage current	$V_{CC} = 3.6 \text{ V}; V_I = V_{CC}$ or GND			1.0		1.0	μA
I_{CC}	Quiescent supply current; SSI	$V_{CC} = 3.6 \text{ V}; V_I = V_{CC}$ or GND; $I_O = 0$			20.0		40	μA
ΔI_{CC}	Additional quiescent supply current per input	$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}; V_I = V_{CC} - 0.6 \text{ V}$			500		850	μA

NOTE:

- All typical values are measured at $T_{amb} = 25 \text{ °C}$.

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AC CHARACTERISTICS

GND = 0 V; $t_r = t_f \leq 2.5$ ns; $C_L = 50$ pF; $R_L = 1$ k Ω

SYMBOL	PARAMETER	WAVEFORM	CONDITION	LIMITS					UNIT
				-40 °C to +85 °C			-40 °C to +125 °C		
				MIN	TYP ¹	MAX	MIN	MAX	
$t_{PHL/PLH}$	Propagation delay nA, nB, nC to nY	Figure 1, 2	$V_{CC}(V)$						ns
			1.2		55				
			2.0		19	36		44	
			2.7		14	26		33	
			3.0 to 3.6		10 ²	21		26	

NOTES:

1. Unless otherwise stated, all typical values are measured at $T_{amb} = 25$ °C.
2. Typical values are measured at $V_{CC} = 3.3$ V.

AC WAVEFORMS

$V_M = 1.5$ V at $V_{CC} \geq 2.7$ V;
 $V_M = 0.5 \times V_{CC}$ at $V_{CC} < 2.7$ V;
 V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load.

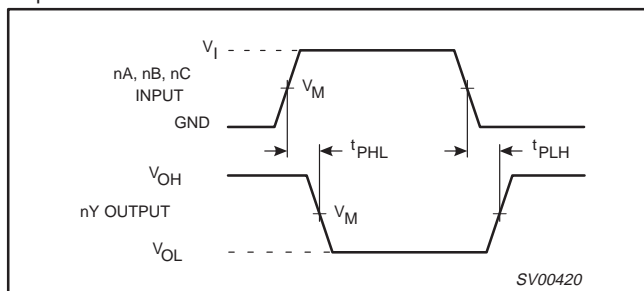


Figure 1. Input (nA, nB, nC) to output (nY) propagation delays.

TEST CIRCUIT

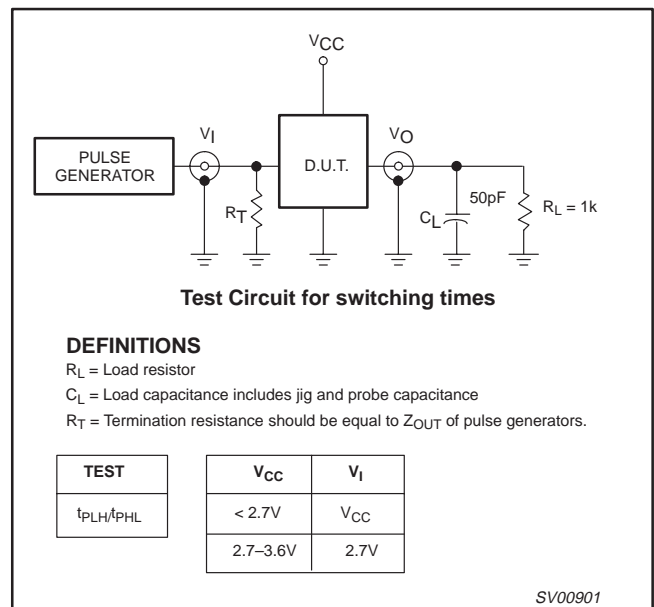


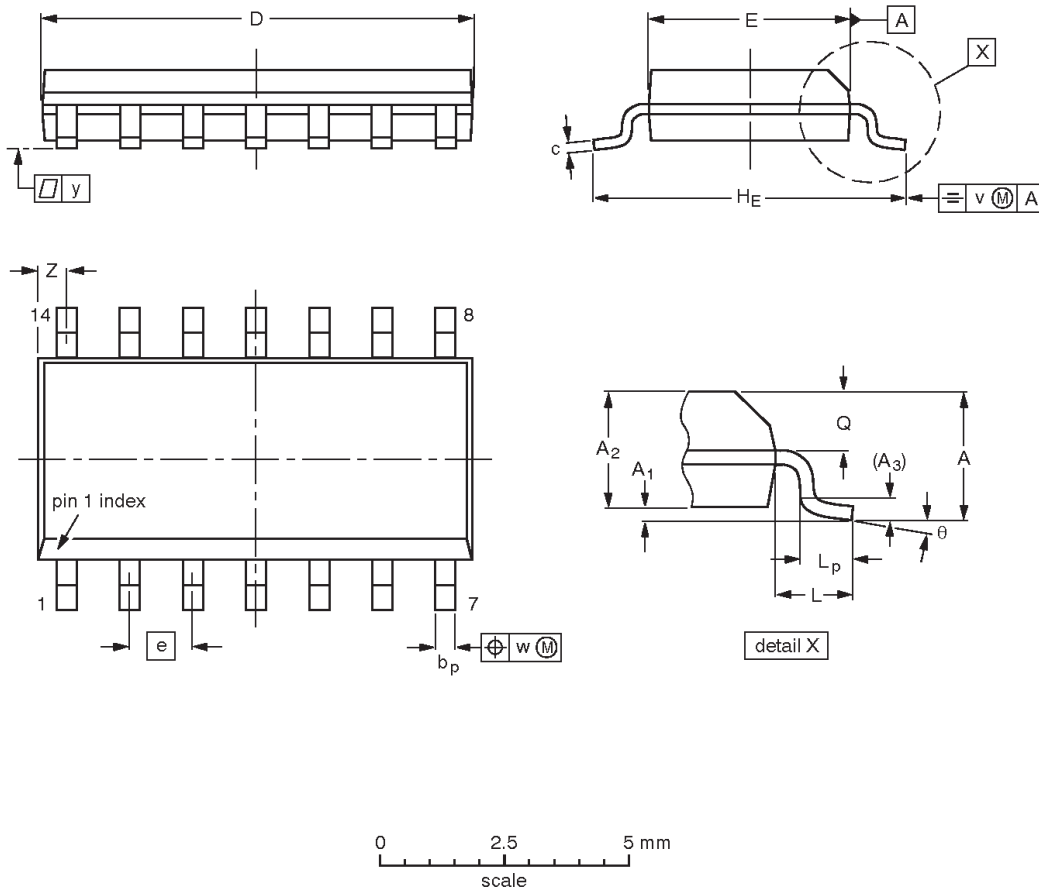
Figure 2. Load circuitry for switching times.

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SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	8.75 8.55	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8° 0°
inches	0.069	0.010 0.004	0.057 0.049	0.01	0.019 0.014	0.0100 0.0075	0.35 0.34	0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016	0.028 0.024	0.01	0.01	0.004	0.028 0.012	

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT108-1	076E06	MS-012				97-05-22 99-12-27

Triple 3-input NAND gate

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REVISION HISTORY

Rev	Date	Description
_3	20030304	Product data (9397 750 11193). ECN 853-1919 29491 of 07 February 2003. Supersedes data of 1998 Apr 20 (9397 750 04407). Modifications: <ul style="list-style-type: none"> • Delete DIL, SSOP and TSSOP package ordering and package outlines (discontinued options). • Correct power dissipation formula.
_2	19980420	Product specification (9397 750 04407). ECN 853-1919 19256 of 20 April 1998. Supersedes data of 1997 Feb 12.

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Document order number:

9397 750 11193

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General description


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Features

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- I_{CC} category: SSI




Datasheet

<u>Type number</u>	<u>Title</u>	<u>Publication release date</u>	<u>Datasheet status</u>	<u>Page count</u>	<u>File size (kB)</u>	<u>Datasheet</u>
74LV10	Triple 3-input NAND gate	3/4/2003	Product specification	7	67	 Download


□ Parametrics

Type number	Package	Description	Propagation Delay(ns)	Voltage	No. of Pins	Power Dissipation Considerations	Logic Switching Levels	Output Drive Capability
74LV10D	SOT108-1 (SO14)	Triple 3-Input NAND Gate	15	Low	14	Low Power or Battery Applications	TTL	Low

□ Products, packages, availability and ordering

<u>Type number</u>	<u>North American type number</u>	<u>Ordering code (12NC)</u>	<u>Marking/Packing</u>  IC packing info	<u>Package</u>	<u>Device status</u>	<u>Buy online</u>
74LV10D	74LV10D	9351 771 30112	Standard Marking * Tube	SOT108-1 (SO14)	Full production	 <input type="checkbox"/>
	74LV10D-T	9351 771 30118	Standard Marking * Reel Pack, SMD, 13"	SOT108-1 (SO14)	Full production	 <input type="checkbox"/>

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